

| CSM212N2DF1006-3 | 00555 | | |
|--|-----------------|------------|----------------|
| 20V N-Channel Enhancement Mode M Voltage 20 V Current | 2 A | DFN1006-3L | Unit: inch(mm) |
| Features | | | |
| Advanced Trench Process Technology Specially Designed for Switch Load, PWM Ag | oplication, etc | | D |
| Mechanical Data | | l | 3 |
| Case : DFN1006-3L Package Terminals : Solderable per MIL-STD-750, Me | thod 2026 | E | |
| • Approx. Weight : 0.00002 ounces, 0.0007 gra | ams | L G | S |

Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

| PARAMETER | | SYMBOL | LIMIT | UNITS | |
|---|----------------------|------------------|-------------|--------|--|
| Drain-Source Voltage | | V _{DS} | 20 | V | |
| Gate-Source Voltage | | V _{GS} | <u>+</u> 12 | | |
| Continuous Drain Current (Note 4) | | ID | 2 | A | |
| Pulsed Drain Current (Note 1) | | I _{DM} | 3 | | |
| Power Dissipation | T _a =25°C | PD | 500 | mW | |
| | Derate above 25°C | | 4 | mW/ °C | |
| Operating Junction and Storage Temperature Range | | TJ,TSTG | -55~150 | ٥C | |
| Typical Thermal resistance - Junction to Ambient ^{(Note 3,} | 4) | R _{θJA} | 250 | °C/W | |

• Limited only By Maximum Junction Temperature



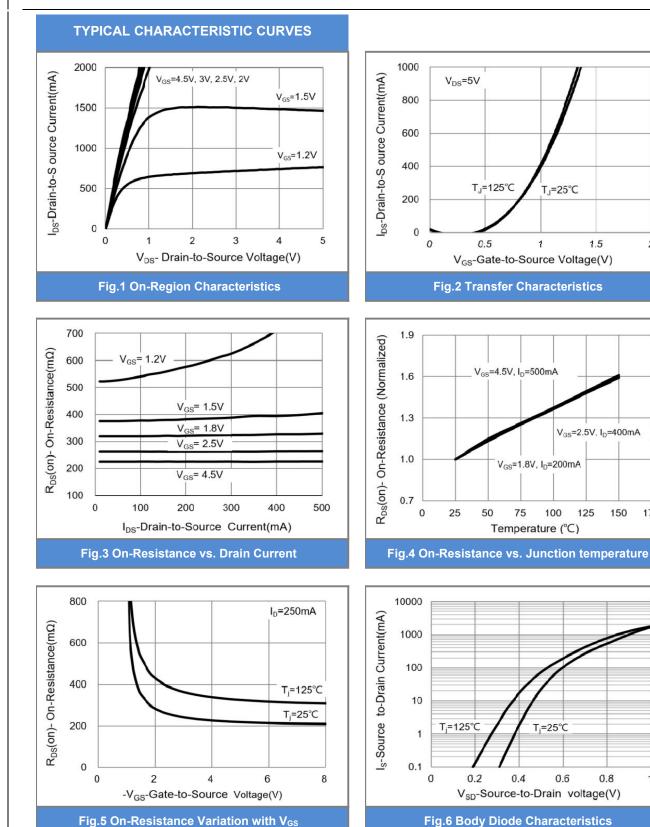
Electrical Characteristics (T_A=25°C unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITION | MIN. | TYP. | MAX. | UNITS | |
|--|---------------------|---|------|------|-------------|-------|--|
| Static | | | - | 1 | | 1 | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V, I _D =250uA | 20 | - | - | | |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} , I _D =250uA | 0.3 | 0.5 | 1 | V | |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} =4.5V, I _D =500mA | - | 220 | 280 | | |
| | | V_{GS} =2.5V, I _D =400mA | - | 250 | 400 | mΩ | |
| | | V _{GS} =1.8V, I _D =200mA | - | 300 | 550 | | |
| | | V _{GS} =1.5V, I _D =100mA | - | 340 | 800 | 1 | |
| | | V _{GS} =1.2V, I _D =100mA | - | 480 | 1500 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =20V, V _{GS} =0V | - | - | 1 | uA | |
| Gate-Source Leakage Current | I _{GSS} | V _{GS} = <u>+</u> 12V, V _{DS} =0V | - | - | <u>+</u> 10 | | |
| Dynamic (Note 5) | | | | | | | |
| Total Gate Charge | Qg | | - | 1.1 | - | nC | |
| Gate-Source Charge | Q _{gs} | V _{DS} =10V, I _D =500mA, V _{GS} =4.5V ^(Note 2) | - | 0.16 | - | | |
| Gate-Drain Charge | Q_{gd} | VGS-4.5V (100 2) | - | 0.12 | - | | |
| Input Capacitance | Ciss | | - | 46 | - | | |
| Output Capacitance | Coss | V _{DS} =10V, V _{GS} =0V, f=1MHZ | - | 15 | - | pF | |
| Reverse Transfer Capacitance | Crss | | - | 3 | - | | |
| Turn-On Delay Time | td _(on) | | - | 5.3 | - | | |
| Turn-On Rise Time | tr | V _{DD} =10V, I _D =500mA, V _{GS} =4.5V, | - | 22 | - | | |
| Turn-Off Delay Time | td _(off) | $V_{GS}=4.5V$, RG=6 Ω (Note 2) | - | 43 | - | ns | |
| Turn-Off Fall Time | tf | | - | 31 | - | | |
| Drain-Source Diode | | | | | | | |
| Maximum Continuous Drain-Source Diode Forward Current | Is | | - | - | 500 | mA | |
| Diode Forward Voltage | V _{SD} | I _S =500mA, V _{GS} =0V | - | 0.7 | 1 | V | |

NOTES :

- 1. Pulse width <300us, Duty cycle <2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
- 4. The maximum current rating is package limited.
- 5. Guaranteed by design, not subject to production testing.





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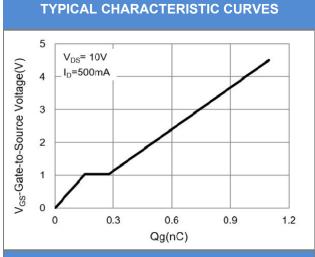


Fig.7 Gate-Charge Characteristics

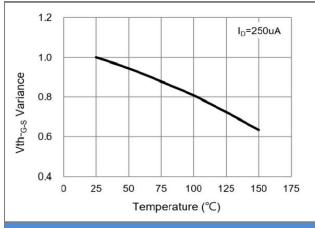
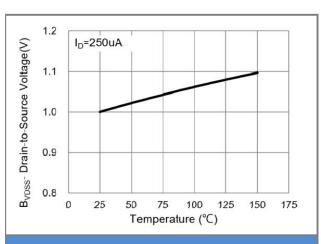


Fig.9 Threshold Voltage Variation with Temperature





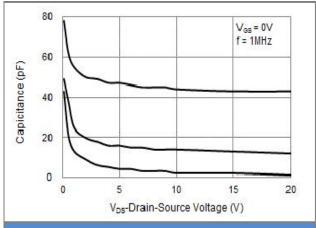


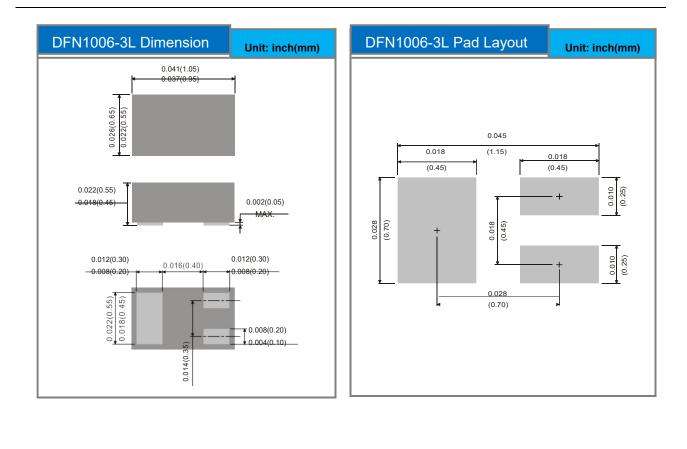
Fig.10 Capacitance vs. Drain-Source Voltage



Part No Packing Code Version

| Part No Packing Code | Package Type | Packing Type |
|----------------------|--------------|-------------------|
| CSM212N2DF1006-3 | DFN1006-3L | 10K pcs / 7" reel |

Packaging Information & Mounting Pad Layout





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